REVISIONS			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Update drawing boilerplate.	04-06-03	Raymond Monnin
B	Added footnote 1 to table II, under group C end-point electricals. Updated drawing paragraphs. -sld	10-07-28	Charles F. Saffle

REV																				
SHEET																				
REV																				
SHEET																				

REV STATUS	REV	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B
OF SHEETS	SHEET	1	2	3	4	5	6	7	8	9	10	11	12	13	14	

PMIC N/A

PREPARED BY
Gary Zahn

CHECKED BY
Michael C. Jones

APPROVED BY
Kendall A. Cottongim

DRAWING APPROVAL DATE
99-06-22

REVISION LEVEL
B

STANDARD MICROCIRCUIT DRAWING

THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE

AMSC N/A

DEFENSE SUPPLY CENTER COLUMBUS
COLUMBUS, OHIO 43218-3990
http://www.dscc.dla.mil

MICROCIRCUIT, HYBRID, LINEAR, ±5 VOLT, DUAL CHANNEL, DC/DC CONVERTER

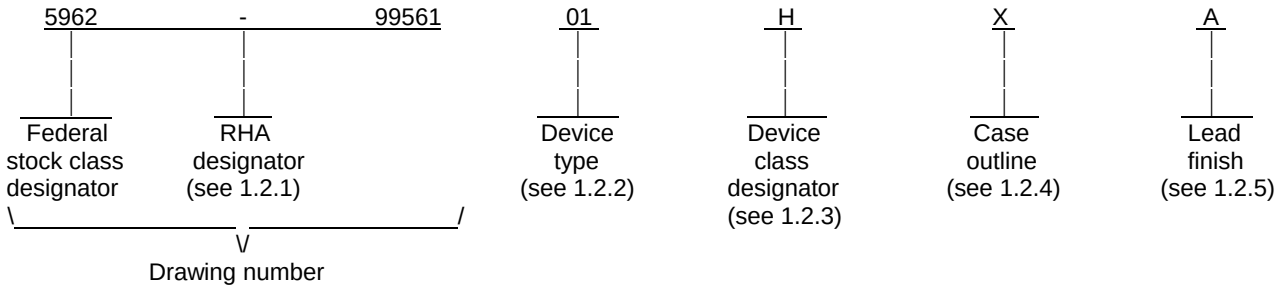
SIZE	CAGE CODE	
A	**67268**	**5962-99561**

SHEET 1 OF 14

1. SCOPE

1.1 Scope. This drawing documents five product assurance classes as defined in paragraph 1.2.3 and MIL-PRF-38534. A choice of case outlines and lead finishes which are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of radiation hardness assurance levels are reflected in the PIN.

1.2 PIN. The PIN shall be as shown in the following example:



1.2.1 Radiation hardness assurance (RHA) designator. RHA marked devices shall meet the MIL-PRF-38534 specified RHA levels and shall be marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.

1.2.2 Device type(s). The device type(s) identify the circuit function as follows:

Device type	Generic number	Circuit function
01	MOR2805D	DC/DC converter, 100 W, ±5 V outputs

1.2.3 Device class designator. This device class designator shall be a single letter identifying the product assurance level. All levels are defined by the requirements of MIL-PRF-38534 and require QML Certification as well as qualification (Class H, K, and E) or QML Listing (Class G and D). The product assurance levels are as follows:

Device class	Device performance documentation
K	Highest reliability class available. This level is intended for use in space applications.
H	Standard military quality class level. This level is intended for use in applications where non-space high reliability devices are required.
G	Reduced testing version of the standard military quality class. This level uses the Class H screening and In-Process Inspections with a possible limited temperature range, manufacturer specified incoming flow, and the manufacturer guarantees (but may not test) periodic and conformance inspections (Group A, B, C, and D).
E	Designates devices which are based upon one of the other classes (K, H, or G) with exception(s) taken to the requirements of that class. These exception(s) must be specified in the device acquisition document; therefore the acquisition document should be reviewed to ensure that the exception(s) taken will not adversely affect system performance.
D	Manufacturer specified quality class. Quality level is defined by the manufacturers internal, QML certified flow. This product may have a limited temperature range.

1.2.4 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	Terminals	Package style
T	See figure 1	12	Tabbed flange mount, lead formed up
U	See figure 1	12	Flange mount, lead formed down
X	See figure 1	12	Flange mount, short lead
Y	See figure 1	12	Tabbed flange mount, short lead
Z	See figure 1	12	Tabbed flange mount, lead formed down

1.2.5 Lead finish. The lead finish shall be as specified in MIL-PRF-38534.

1.3 Absolute maximum ratings. 1/

Input voltage range (V_{IN}) 2/	-0.5 V dc to +50 V dc
Power dissipation (P_D)	27 W
Lead soldering temperature (10 seconds)	+300°C
Storage temperature range	-65°C to +150°C

1.4 Recommended operating conditions.

Input voltage range (V_{IN})	+16 V dc to +40 V dc
Output power	$\leq$ 100 W
Case operating temperature range (T_C)	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38534 - Hybrid Microcircuits, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.
MIL-STD-1835 - Interface Standard for Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.
MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at https://assist.daps.dla.mil/quicksearch/ or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

1/ Stresses above the absolute maximum ratings may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.
2/ An undervoltage lockout circuit shuts the unit off when the input voltage drops to approximately 14.5 volts. Operation of the unit between 14.5 volts and 16 volts is nondestructive, but performance is not guaranteed.

3. REQUIREMENTS

3.1 Item requirements. The individual item performance requirements for device classes D, E, G, H, and K shall be in accordance with MIL-PRF-38534. Compliance with MIL-PRF-38534 may include the performance of all tests herein or as designated in the device manufacturer's Quality Management (QM) plan or as designated for the applicable device class. The manufacturer may eliminate, modify or optimize the tests and inspections herein, however the performance requirements as defined in MIL-PRF-38534 shall be met for the applicable device class. In addition, the modification in the QM plan shall not affect the form, fit, or function of the device for the applicable device class.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38534 and herein.

3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein and figure 1.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 2.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full specified operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.

3.5 Marking of device(s). Marking of device(s) shall be in accordance with MIL-PRF-38534. The device shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's vendor similar PIN may also be marked.

3.6 Data. In addition to the general performance requirements of MIL-PRF-38534, the manufacturer of the device described herein shall maintain the electrical test data (variables format) from the initial quality conformance inspection group A lot sample, for each device type listed herein. Also, the data should include a summary of all parameters manually tested, and for those which, if any, are guaranteed. This data shall be maintained under document revision level control by the manufacturer and be made available to the preparing activity (DSCC-VA) upon request.

3.7 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to supply to this drawing. The certificate of compliance (original copy) submitted to DSCC-VA shall affirm that the manufacturer's product meets the performance requirements of MIL-PRF-38534 and herein.

3.8 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38534 shall be provided with each lot of microcircuits delivered to this drawing.

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38534 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

4.2 Screening. Screening shall be in accordance with MIL-PRF-38534. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DSCC-VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.

(2) T_C as specified in accordance with table I of method 1015 of MIL-STD-883.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions $-55°C \le T_C \le +125°C$ V_{IN} = 28 V dc ±0.5 V dc no external sync, C_L = 0 unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Output voltage ($+V_{OUT}$)	V_{OUT}	I_{OUT} = +10 A dc, (main)	1	01	+4.95	+5.05	V dc
			2, 3		+4.875	+5.125	
($-V_{OUT}$)		I_{OUT} = -10 A dc, (dual)	1		-4.920	-5.080	
			2, 3		-4.820	-5.180	
Output current 1/	I_{OUT}	V_{IN} = 16 V dc, 28 V dc, and 40 V dc, sum of both outputs	1, 2, 3		0	20	A
V_{OUT} ripple voltage	V_{RIP}	I_{OUT} = 10 A, B.W. = 10 kHz to 20 MHz	1			75	mV p-p
			2, 3			80	
V_{OUT} line regulation	VR_{LINE}	V_{IN} = 40 V dc to 16 V dc, I_{OUT} = 10 A dc, (main)	1, 2, 3			50	mV
		V_{IN} = 40 V dc to 16 V dc, I_{OUT} = 10 A dc, (dual)				100	
V_{OUT} load regulation ($+V_{OUT}$)	VR_{LOAD}	I_{OUT} = 0 to 10 A, (main)	1, 2, 3			50	mV
($-V_{OUT}$)		I_{OUT} = 0 to 10 A, (dual)				150	
Input current	I_{IN}	I_{OUT} = 0, inhibit 1 (pin 4) = 0	1, 2, 3			10	mA
		I_{OUT} = 0, inhibit 2 (pin 12) = 0				70	
		I_{OUT} = 0, inhibit 1 and 2 (pins 4 and 12) = open				160	
I_{IN} ripple current	I_{RIP}	I_{OUT} = 10 A, B.W. = 10 kHz to 20 MHz	1			120	mA p-p
			2, 3			130	
Efficiency	Eff	I_{OUT} = 10 A	1		78		%
			2, 3		77		
Isolation	ISO	Input to output or any pin to case at 500 V dc, T_C = +25°C	1		100		MΩ
Capacitive load 2/ 3/	C_L	No effect on dc performance, T_C = +25°C	4			1000	µF
Power dissipation, load fault	P_D	Short circuit	1,2,3			27	W

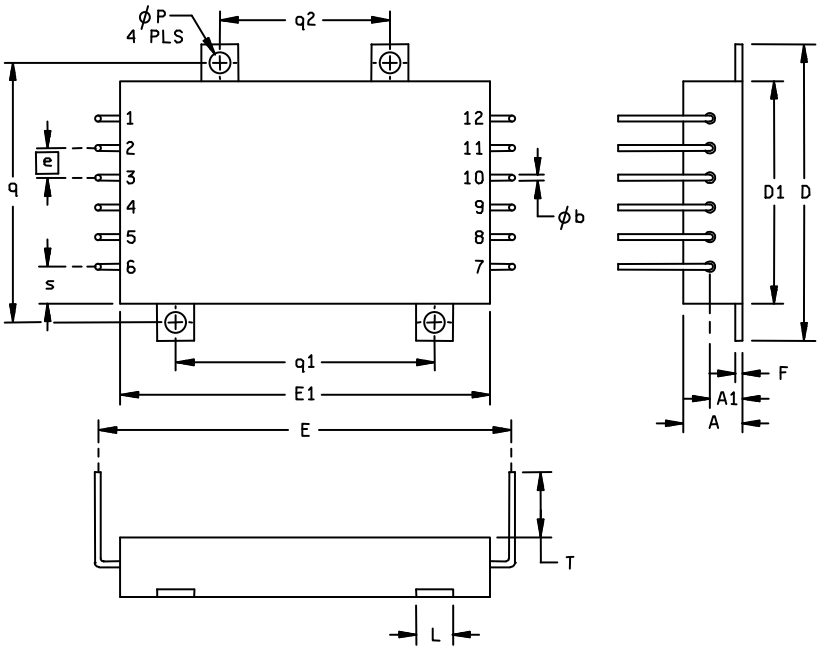
See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions $-55°C \le T_C \le +125°C$ V_{IN} = 28 V dc ±0.5 V dc no external sync, C_L = 0 unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Switching frequency	F_S	I_{OUT} = 10 A	4	01	480	580	kHz
			5, 6		460	600	
External sync range 4/	F_{SYNC}	I_{OUT} = 10 A, TTL level to pin 6	4, 5, 6		525	625	kHz
Step V_{OUT} load transient 5/	V_{TLOAD}	50 percent load to/from 100 percent load			-250	+250	mV pk
Recovery time, step V_{OUT} transient 3/ 5/ 6/	TT_{LOAD}	50 percent load to/from 100 percent load				200	µs
Step V_{OUT} transient lines 3/ 7/	V_{TLINE}	Input step from 40 V dc to 16 V dc, I_{OUT} = 10 A			-400	+400	mV pk
		Input step from 16 V dc to 40 V dc, I_{OUT} = 10 A			-400	+400	
Recovery step V_{OUT} line transient 3/ 6/	TT_{LINE}	Input step from 16 V dc to 40 V dc, I_{OUT} = 10 A				300	µs
		Input step from 40 V dc to 16 V dc, I_{OUT} = 10 A				300	
Start up overshoot 3/	$Vton_{os}$	I_{OUT} = 10 A, V_{IN} = 0 to 28 V dc				50	mV pk
Start up delay 8/	Ton_D	I_{OUT} = 10 A, V_{IN} = 0 to 40 V dc				10	ms
Load fault recovery 3/	Tr_{LF}	I_{OUT} = 10 A				10	ms

1/ The output power available from either output is limited to 70 watts (i.e. 70 percent of the total output power), while the other maintains a minimum of 15 percent of the total output power used.
2/ Capacitive load may be any value from 0 to the maximum limit without compromising dc performance.
3/ Parameter shall be tested as part of design characterization and after design or process changes; therefore, the parameter shall be guaranteed to the limits specified in table I.
4/ A TTL level waveform (V_{IH} = 4.5 V minimum, V_{IL} = 0.8 V maximum) with a 50 percent ±10 percent duty cycle applied to the sync input pin (pin 6) within the sync range frequency shall cause the converter's switching frequency to become synchronous with the frequency applied to the sync input pin (pin 6).
5/ Load step transition time is 50 microseconds minimum.
6/ Recovery time is measured from the initiation of the transient until V_{OUT} has returned to within ± 1 percent of its final value.
7/ Input step transition time greater than 10 microseconds.
8/ Start up delay time measurement is either for a step application of power at the input or the removal of a ground signal from the inhibit pin 1 (pin 4) or inhibit 2 pin (pin 12) while power is applied to the input.

Case outline T.

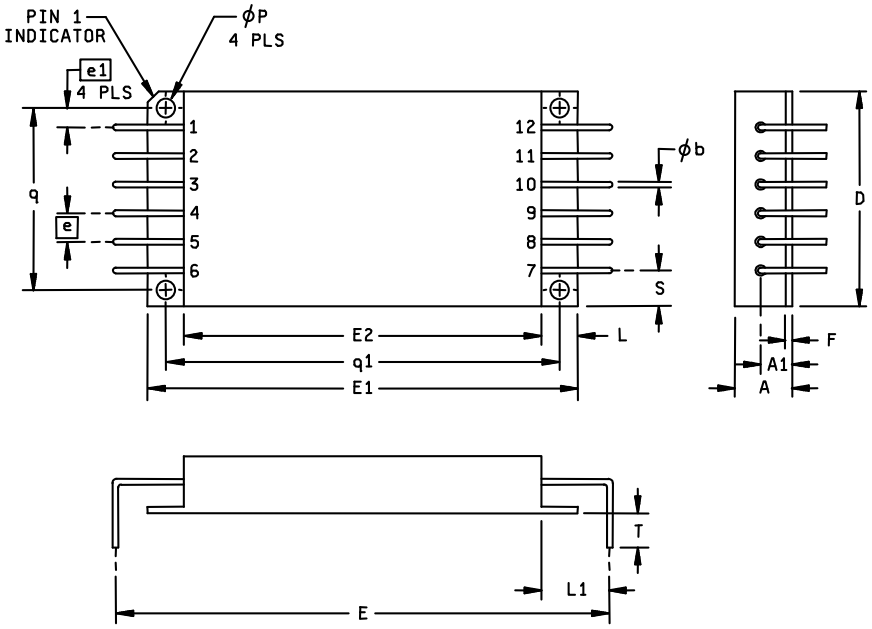


Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		10.16		.400
A1	5.33	5.84	.210	.230
∅b	0.89	1.14	.035	.045
D	50.55	51.05	1.990	2.010
D1	37.85	38.35	1.490	1.510
e	5.08 BSC		.200 BSC	
E	69.85	72.39	2.750	2.850
E1	63.25	63.75	2.490	2.510
F	1.14	1.40	.045	.055
L	6.10	6.60	.240	.260
∅P	3.43	3.68	.135	.145
q/q1	44.32	44.58	1.745	1.755
q2	29.08	29.34	1.145	1.155
s	6.22	6.48	.245	.255
T	9.91	12.45	.390	.490

NOTES:
1. The U.S. preferred system of measurement is the metric SI. This case outline was originally designed using inch-pound units of measurement, in the event of conflict between the metric and inch-pound units, the inch-pound units shall take precedence.
2. Device weight: 110 grams maximum.

FIGURE 1. Case outline(s).

Case outline U.

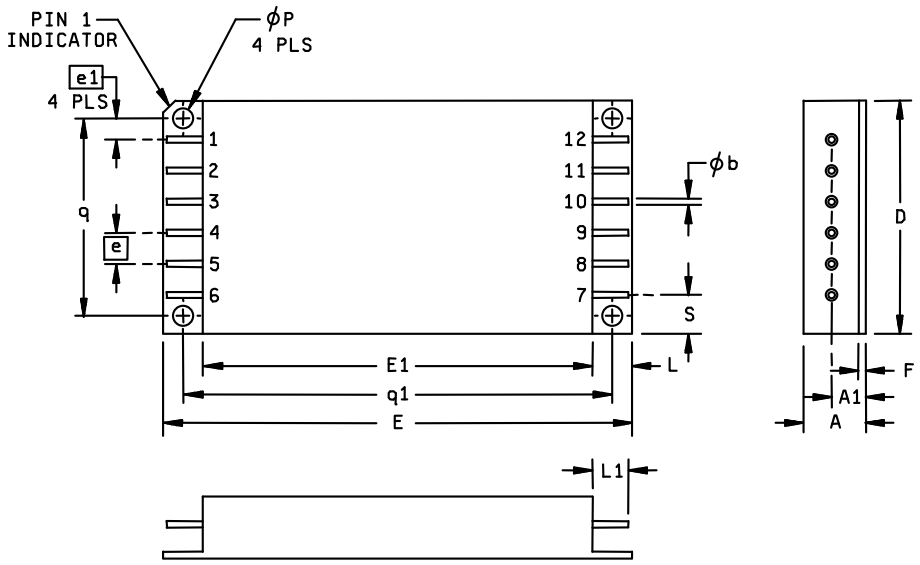


Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		10.16		.400
A1	4.95	6.22	.195	.245
∅b	0.89	1.14	.035	.045
D	37.72	38.23	1.485	1.505
e	5.08 BSC		.200 BSC	
e1	3.30 BSC		.130 BSC	
E	87.38	87.88	3.440	3.460
E1	75.82	76.33	2.985	3.005
E2	63.37	63.63	2.495	2.505
F	1.14	1.40	.045	.055
L	6.10	6.60	.240	.260
L1	11.81	12.32	.465	.485
∅P	3.12	3.38	.123	.133
q	31.88	32.13	1.255	1.265
q1	69.98	70.23	2.755	2.765
S	6.22	6.48	.245	.255
T	5.08	7.62	.200	.300

NOTES:
1. The U.S. preferred system of measurement is the metric SI. This case outline was originally designed using inch-pound units of measurement, in the event of conflict between the metric and inch-pound units, the inch-pound units shall take precedence.
2. Device weight: 110 grams maximum.

FIGURE 1. Case outline(s) - Continued.

Case outline X.

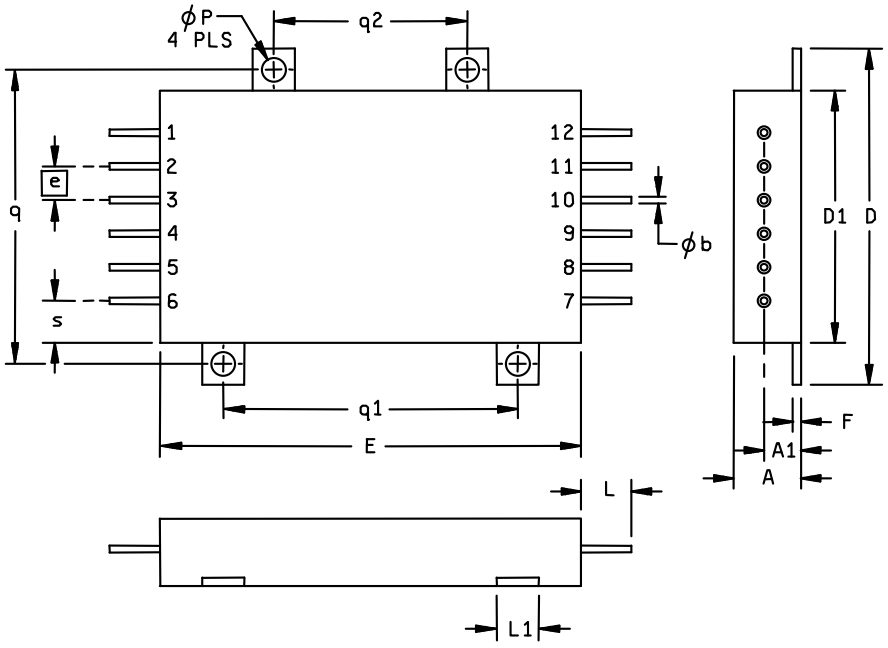


Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		10.16		.400
A1	5.33	5.84	.210	.230
∅b	0.89	1.14	.035	.045
D	37.72	38.23	1.485	1.505
e	5.08 BSC		.200 BSC	
e1	3.30 BSC		.130 BSC	
E	75.82	76.33	2.985	3.005
E1	63.37	63.63	2.495	2.505
F	1.14	1.40	.045	.055
L	6.10	6.60	.240	.260
L1	6.35	8.89	.250	.350
∅P	3.12	3.38	.123	.133
q	31.88	32.13	1.255	1.265
q1	69.98	70.23	2.755	2.765
S	6.22	6.48	.245	.255

NOTES:
1. The U.S. preferred system of measurement is the metric SI. This case outline was originally designed using inch-pound units of measurement, in the event of conflict between the metric and inch-pound units, the inch-pound units shall take precedence.
2. Device weight: 110 grams maximum.

FIGURE 1. Case outline(s) - Continued.

Case outline Y.

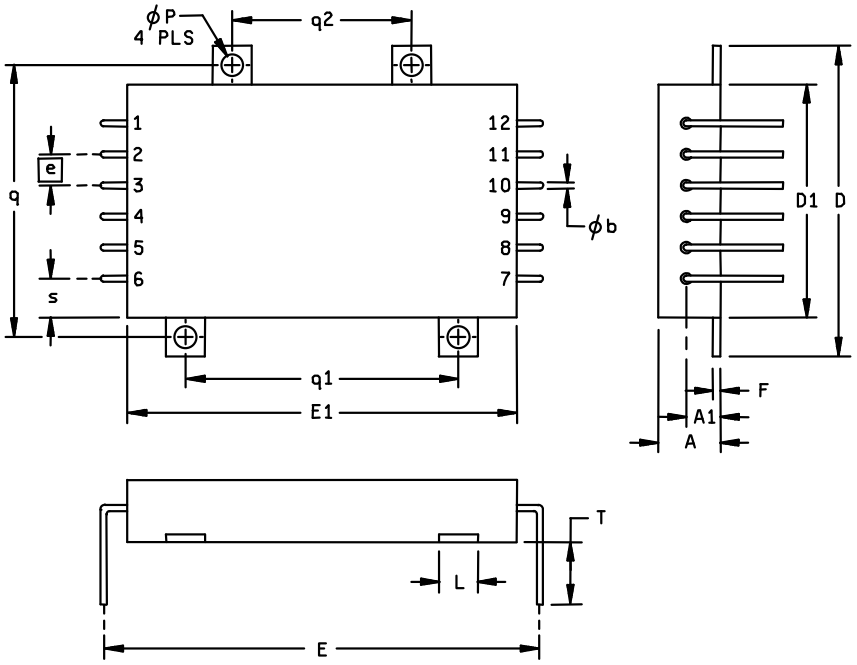


Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		10.16		.400
A1	5.33	5.84	.210	.230
∅b	0.89	1.14	.035	.045
D	50.55	51.05	1.990	2.010
D1	37.85	38.35	1.490	1.510
e	5.08 BSC		.200 BSC	
E	63.25	63.75	2.490	2.510
F	1.14	1.40	.045	.055
L	6.35	8.89	.250	.350
L1	6.10	6.60	.240	.260
∅P	3.43	3.68	.135	.145
q/q1	44.32	44.58	1.745	1.755
q2	29.08	29.34	1.145	1.155
s	6.22	6.48	.245	.255

NOTES:
1. The U.S. preferred system of measurement is the metric SI. This case outline was originally designed using inch-pound units of measurement, in the event of conflict between the metric and inch-pound units, the inch-pound units shall take precedence.
2. Device weight: 110 grams maximum.

FIGURE 1. Case outline(s) - Continued.

Case outline Z.



Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		10.16		.400
A1	5.33	5.84	.210	.230
b	0.89	1.14	.035	.045
D	50.55	51.05	1.990	2.010
D1	37.85	38.35	1.490	1.510
e	5.08 BSC		.200 BSC	
E	69.85	72.39	2.750	2.850
E1	63.25	63.75	2.490	2.510
F	1.14	1.40	.045	.055
L	6.10	6.60	.240	.260
∅P	3.43	3.68	.135	.145
q/q1	44.32	44.58	1.745	1.755
q2	29.08	29.34	1.145	1.155
s	6.22	6.48	.245	.255
T	7.87	10.41	.310	.410

NOTES:
1. The U.S. preferred system of measurement is the metric SI. This case outline was originally designed using inch-pound units of measurement, in the event of conflict between the metric and inch-pound units, the inch-pound units shall take precedence.
2. Device weight: 110 grams maximum.

FIGURE 1. Case outline(s) - Continued.

Device type	01
Case outlines	T, U, X, Y, and Z
Terminal number	Terminal symbol
1	Positive Input
2	Input common
3	Case
4	Inhibit 1
5	Sync output
6	Sync input
7	Positive output
8	Output return
9	Negative output
10	Trim
11	Share
12	Inhibit 2

FIGURE 2. Terminal connections.

TABLE II. Electrical test requirements.

MIL-PRF-38534 test requirements	Subgroups (in accordance with MIL-PRF-38534, group A test table)
Interim electrical parameters	---
Final electrical parameters	1*, 2, 3, 4, 5, 6
Group A test requirements	1, 2, 3, 4, 5, 6
Group C end-point electrical 1/ parameters	1, 2, 3
End-point electrical parameters for radiation hardness assurance (RHA) devices	Not applicable

1/ As a minimum, for all Group C testing performed after (10-07-28) manufacturers shall perform subgroups 1, 2, and 3 from the Group A electrical test table (Table C-Xa of MIL-PRF-38534).
* PDA applies to subgroup 1.

4.3 Conformance and periodic inspections. Conformance inspection (CI) and periodic inspection (PI) shall be in accordance with MIL-PRF-38534 and as specified herein.

4.3.1 Group A inspection (CI). Group A inspection shall be in accordance with MIL-PRF-38534 and as follows:

a. Tests shall be as specified in table II herein.

b. Subgroups 7, 8, 9, 10, and 11 shall be omitted.

4.3.2 Group B inspection (PI). Group B inspection shall be in accordance with MIL-PRF-38534.

4.3.3 Group C inspection (PI). Group C inspection shall be in accordance with MIL-PRF-38534 and as follows:

a. End-point electrical parameters shall be as specified in table II herein.

b. Steady-state life test, method 1005 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DSCC-VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.

(2) T_C as specified in accordance with table I of method 1005 of MIL-STD-883.

(3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

4.3.4 Group D inspection (PI). Group D inspection shall be in accordance with MIL-PRF-38534.

4.3.5 Radiation Hardness Assurance (RHA) inspection. RHA inspection is not currently applicable to this drawing.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38534.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users as specified in MIL-PRF-38534.

6.4 Record of users. Military and industrial users shall inform Defense Supply Center Columbus (DSCC) when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.

6.5 Comments. Comments on this drawing should be directed to DSCC-VA, Post Office Box 3990, Columbus, Ohio 43218-3990, or telephone (614) 692-1081.

6.6 Sources of supply. Sources of supply are listed in MIL-HDBK-103 and QML-38534. The vendors listed in MIL-HDBK-103 and QML-38534 have submitted a certificate of compliance (see 3.7 herein) to DSCC-VA and have agreed to this drawing.

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 10-07-28

Approved sources of supply for SMD 5962-99561 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38534 during the next revisions. MIL-HDBK-103 and QML-38534 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This information bulletin is superseded by the next dated revisions of MIL-HDBK-103 and QML-38534.

Standard microcircuit drawing PIN 1/	Vendor CAGE number	Vendor similar PIN 2/
5962-9956101HTA 5962-9956101HTC	50821 50821	MOR2805DW/883 MOR2805DW/883
5962-9956101HUA 5962-9956101HUC	50821 50821	MOR2805DV/883 MOR2805DV/883
5962-9956101HXA 5962-9956101HXC	50821 50821	MOR2805D/883 MOR2805D/883
5962-9956101HYA 5962-9956101HYC	50821 50821	MOR2805DY/883 MOR2805DY/883
5962-9956101HZA 5962-9956101HZC	50821 50821	MOR2805DZ/883 MOR2805DZ/883

1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the Vendor to determine its availability.

2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number	Vendor name and address
50821	Interpoint Corporation 10301 Willows Road Redmond, WA 98073-9705